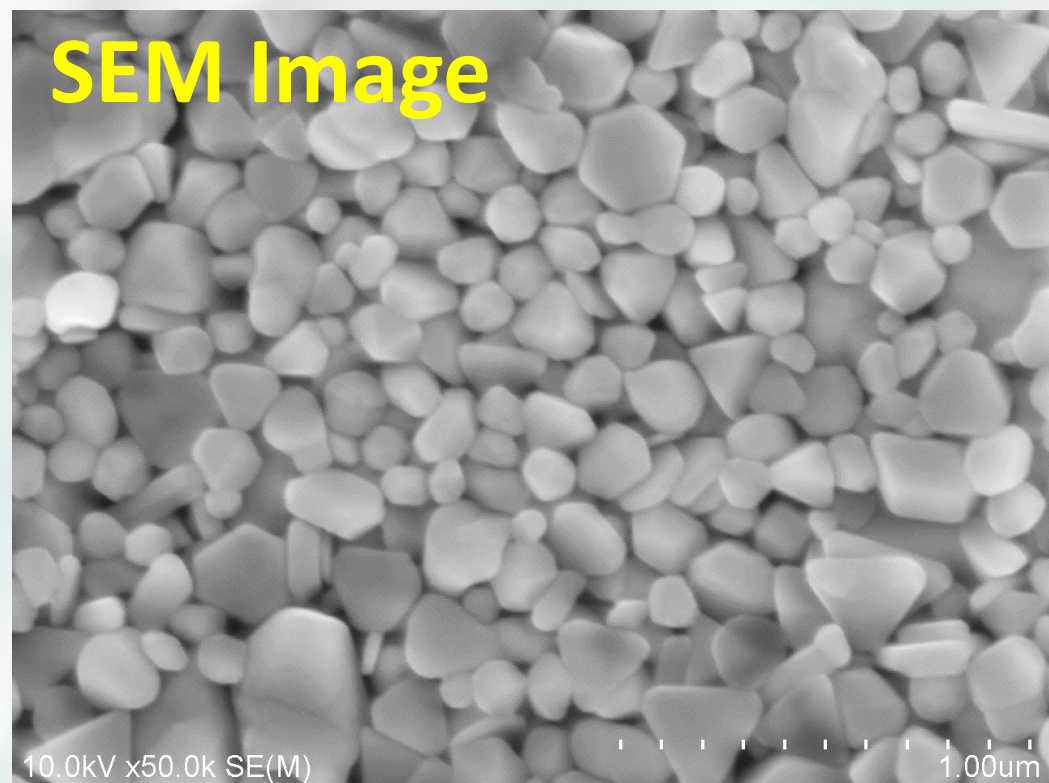


for High Performance Conductive Adhesive Paste

KM120 (Low Temperature Sintering)



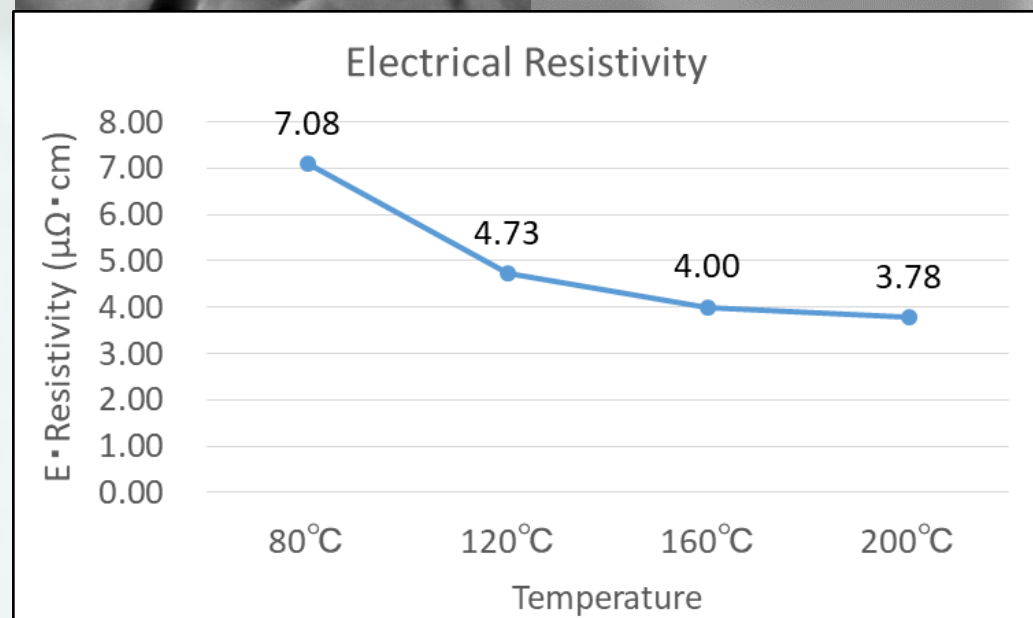
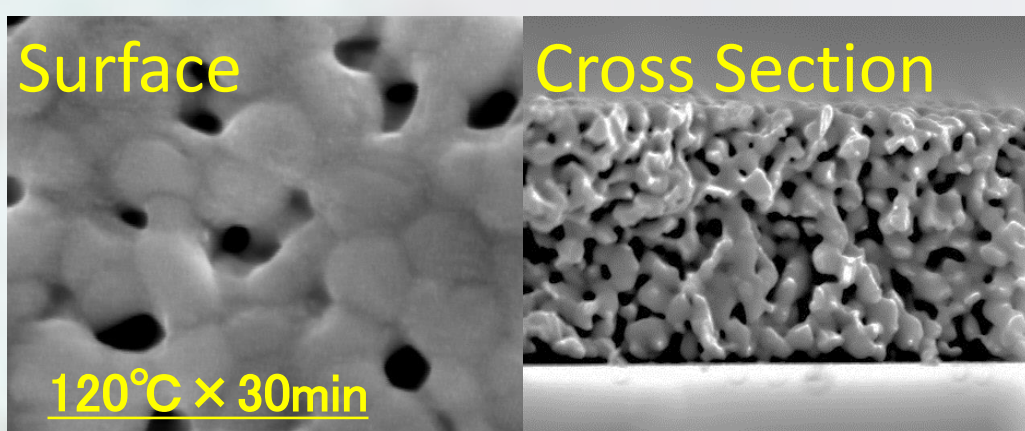
SEM Image



Product Name	D50 (μm)	T.D (g/ml)	BET (m ² /g)	Sintering Temp.(°C)
KM120	0.15 ~ 0.30	3.0 ~ 4.5 (Reference Data)	1.5 ~ 2.5 (Reference Data)	120

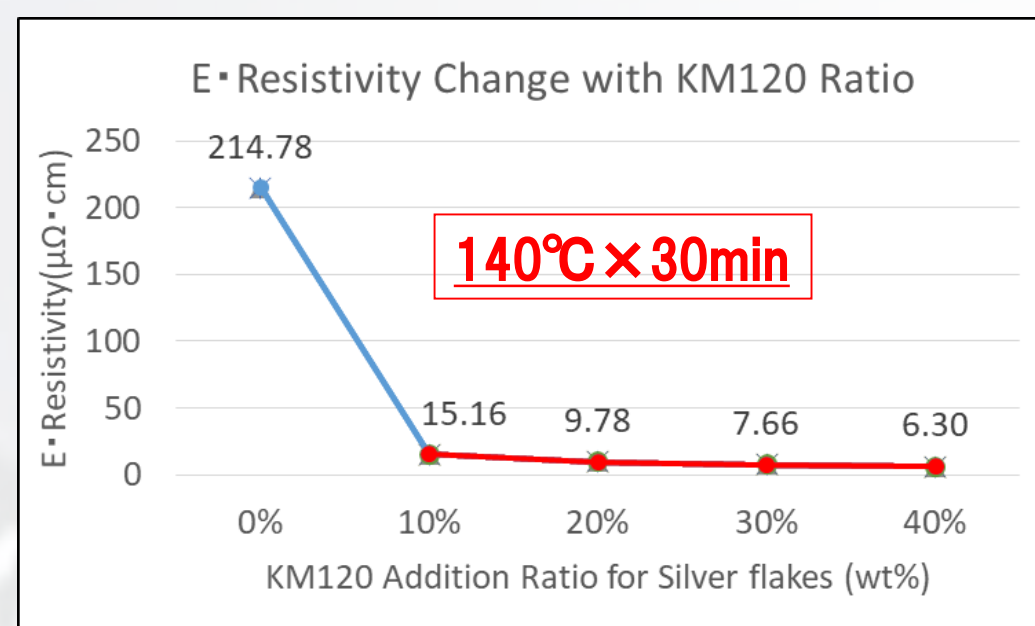
The KM120 achieved low temperature sintering at 120 °C due to its optimized particle size and shape. In addition, it realizes the required properties in various applications as the conductive paste, thermal interface material, adhesive filler and etc.

☞Point.1 High Performance at Low Temp.



✓ Realize the Better Sintering and Better Conductivity at Low Temperature Process.

☞Point.2 Combination with Silver Flakes



✓ For Use as an Additive to Improve the Specific Properties.

☞Point.3 Other Benefit

✓ Pre-dispersed with High Concentration in a Solvent Specified by the Customer



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